

SPECIFICATION

COMMERCIALY AVAILABLE

CERAMIC FILTER
PART NUMBER: CF-26103005A

Revision Made: Updated Package

ISSUED / REVISION	ENGINEER APPROVED	DOCUMENT CHECKED	DRAFTSMAN
9/10/05 **	7/8/10 SW	7/82010 BF	7/8/2010 GL
7/29/2010 DS	7/29/2010 SRJ	8/2/2010 BF	8/2/2010 GL

FILTRONETICS Inc

1. APPLICATION

THIS SPECIFICATION APPLIES TO A BAND PASS FILTER USING DIELECTRIC RESONATOR.

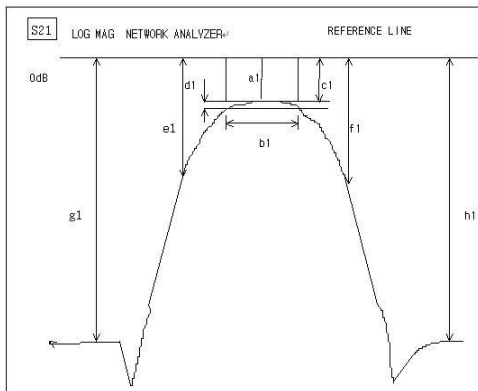
2. PART NUMBER

PART NO	CF-26103005A
PACKAGING	PLASTIC TRAY

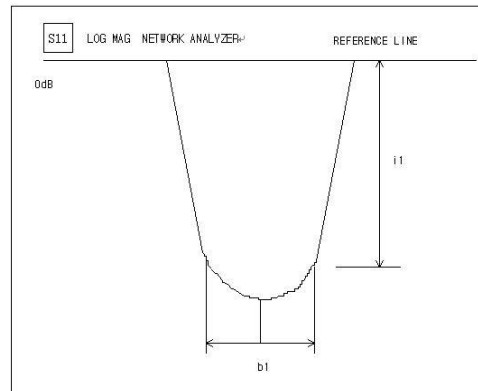
3. SPECIFICATIONS

NO	ITEMS	Ref.	SPECIFICATION
1	Center Frequency (Fo)	a1	2610 MHz
2	3.0 dBc PASS Band (PB)	b1	300 MHz ± 10%
3	Insertion Loss @ Fo	a1	3.0 dB Max
4	V.S.W.R over 80% of 3 dB BW	-	1.75:1 Min
5	Attenuation	@ 2098 MHz	40 dBc Min
		@ 3122 MHz	40 dBc Min
6	Group Delay Variation over 80% of 3 dB BW	-	20 nSec Max
7	Impedance	-	50Ω
8	Maximum Input Power	-	1 W (+30 dBm)
9	Operating Temperature Range	-	-40 to +85°C
10	Workmanship	-	IPC-610 class 2
11	Processing Temp	-	+150°C for 1 hour +230°C for 10 minutes

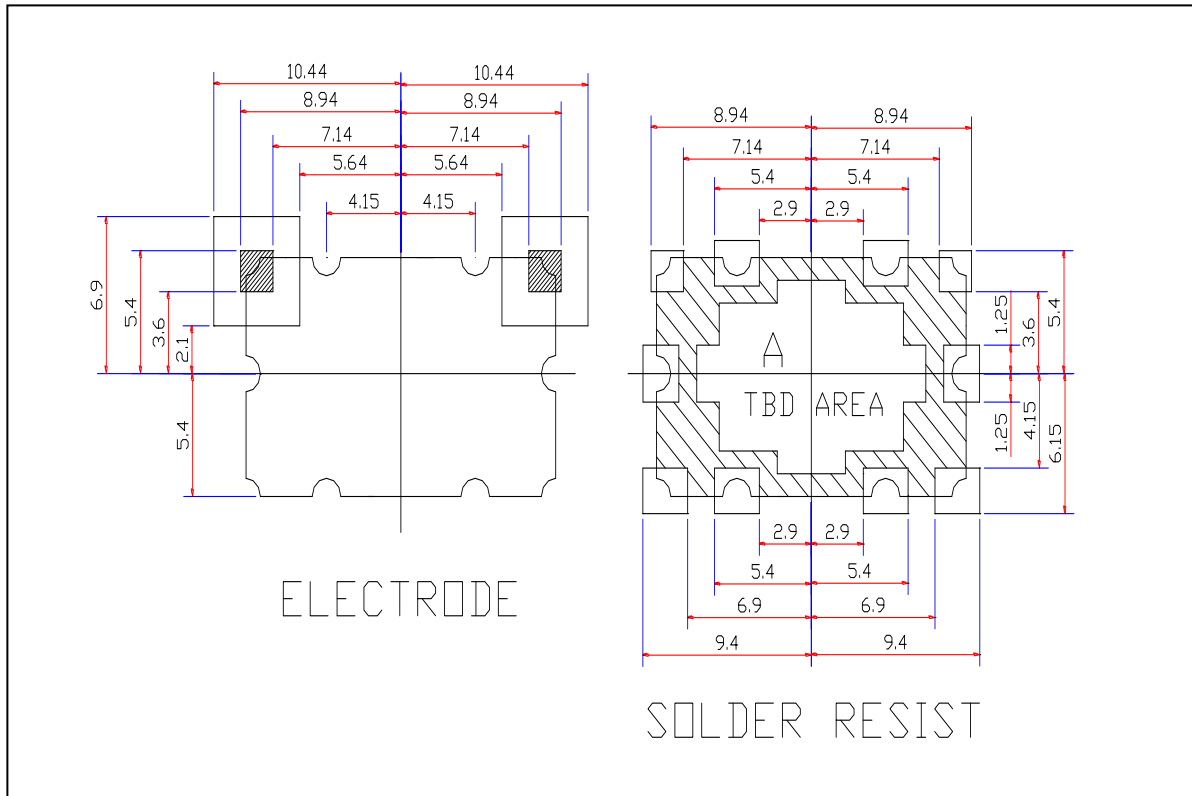
S21 LOG MAG NETWORK ANALYZER



S11 LOG MAG NETWORK ANALYZER



Recommended Solder Pattern:

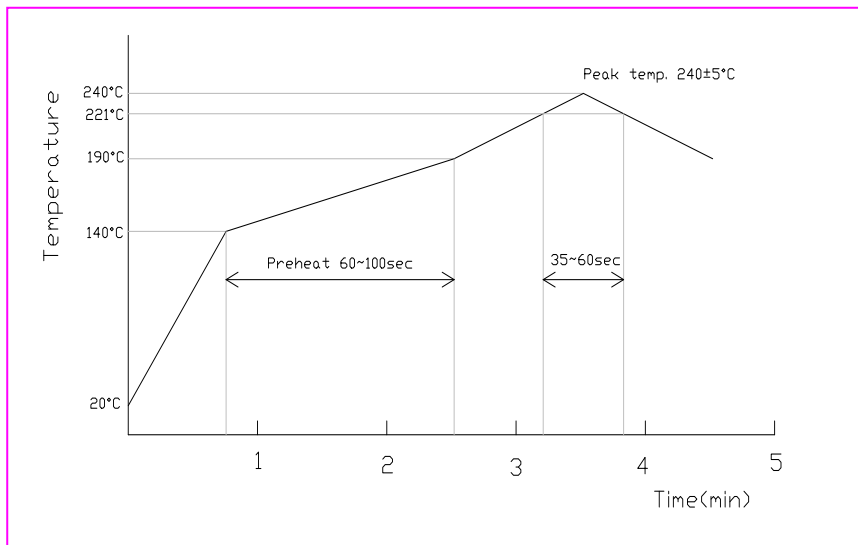


<p align="center">Quality Conformance Test 100% Final inspection 100% Test Data</p>	
1)	Visual mechanical to IPC-610 Class 2 Including inspection for cleanliness.
2)	Thermal Shock -44 to +85°C 10 cycles
3)	Electrical Specifications at ambient

5. DEFINITIONS

TERMS	DESCRIPTION	SPECIFICATION
Center Frequency	The midpoint of through band pass filter pass band, normally expressed as the arithmetic mean of the -3 dB point. Also called Fo.	3. SPECIFICATION
Pass Band Width	The width of the pass band of a filter referenced to the minimum insertion loss point in the pass band. The pass band of a filter is stated as -1.0 dB bandwidth.	
Insertion Loss	The loss of the filter, in dB measured at center frequency relative to a through line (0 dB).	
Attenuation	Reduction of RF power through a filter measured in dB, at desired band and referenced to 0 dB. (Filter to be removed from circuit)	
Pass Band Ripple	Variations in loss in the pass band of the filter, superimposed upon the fundamental shape of the pass band.	
V.S.W.R in Pass Band	The ratio of the maximum value of a standing wave to its minimum value, related to the return loss in pass band.	
Date Code	Each date code shall be from a single lot	
Lot	One Batch of parts processed in a single manufacturing run. A single lot shall have no more than one firing, plating, soldering, or other batch processing.	
Cleanliness	Parts shall be clean. They shall be free from smudges, loose solder, solder spatter, metal chips or mold release agents. No burrs. Particles or any foreign material over 0.2 mm which might detract from the intended operation, function or appearance of the part.	

6. REFLOW SOLDERING STANDARD CONDITIONS



- Measuring point of temperature in-out terminals of the device.
- Reflow Soldering
- Both convection and infrared rays
- Hot air
- Solder Cream: Sn96.5/Ag3.5

7. RELIABILITY TEST AND CONDITIONS

ITEM	TEST CONDITIONS	REQUIREMENTS																		
Resistance to solder heat	Preheat temperature : 120 to 150°C Preheat time: 1 to 1.5 min Solder temperature: 260 +/- 10°C Dipping time: 10 +/- 0.5 sec →Soldering Time : 5sec.max.per each terminal	No damage such as cracks should be caused in chip element.																		
Solderability	Preheat temperature: 120 to 150°C Preheat time: 1 to 1.5 min Solder temperature: 235 +/- 5°C Dipping time: 5 +/- 1 sec	More than 80% of the terminal electrode shall be covered with new solder																		
Heat resistance (High-temperature Load)	Temperature: 85 +/- 2°C Applied voltage: Rated voltage Applied current: Rated current Recovery: 1 to 2hrs of recovery under the standard condition after the removal from test chamber.	No mechanical damage. After test, the device shall satisfy the specification in section 3. Standard condition is 25+/-5°C and Less than 65% relative humidity																		
Thermal shock (Temperature cycle)	Conditions for 1 cycle Step 1: + 85°C 15 min Step 2 : - 44°C 15 min Number of cycle: 10	No mechanical damage. After test, the device shall satisfy the specification in section 3.																		
Humidity Resistance	Temperature: 40 +/- 2°C Humidity: 90 to 95% RH Duration: 96 +/- 5 hrs Recovery: 1 to 2hrs of recovery under the standard condition after the removal from test chamber.	No mechanical damage. After test, the device shall satisfy the specification in section 3.																		
Vibration	Direction: X, Y and Z <table border="1"> <thead> <tr> <th>Frequency (Hz)</th> <th>PSD</th> </tr> </thead> <tbody> <tr> <td>15</td> <td>0.02</td> </tr> <tr> <td>30</td> <td>0.08</td> </tr> <tr> <td>300</td> <td>0.08</td> </tr> <tr> <td>600</td> <td>0.20</td> </tr> <tr> <td>700</td> <td>0.8</td> </tr> <tr> <td>1000</td> <td>0.8</td> </tr> <tr> <td>1200</td> <td>0.05</td> </tr> <tr> <td>2000</td> <td>0.02</td> </tr> </tbody> </table> Time: each 30 min for all directions	Frequency (Hz)	PSD	15	0.02	30	0.08	300	0.08	600	0.20	700	0.8	1000	0.8	1200	0.05	2000	0.02	No mechanical damage. After test, the device shall satisfy the specification in section 3.
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2000	0.02																			
Shock	53 G, 11 ms terminal Sawtooth, 3 times in each of the 6 primary axes	No mechanical damage. After test, the device shall satisfy the specification in section 3.																		

Vibration: The device is subjected to vibration of 2 sweeps in each of three mutually perpendicular planes
Frequency shall be varied within 10~50Hz with 1.5mm double amplitude and within 50~500 Hz with 10G's acceleration. Sweep time of Frequency Shall be 15minutes.

Shock: The device is subjected to 3 shocks in each direction of six mutually perpendicular planes
Each shock shall be a half-sine wave shaped with a magnitude of 30G's and duration of 11 msec.